TE Internal #: 6123833-1

TE Internal Description: M-ZIF PLUG ASSY 260P 3.8SOLDER

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Connectors > Rectangular Connectors > Standard Rectangular Connectors



Product Type: Connector

Connector & Housing Type: Plug

Mating Alignment: With

Mating Alignment Type: Guide Hole

Mating Retention: With

### **Features**

### **Product Type Features**

Troduct Type reduces	
Product Style	Assembly
Strain Relief	Without
Connector Type	Header
Shape	Rectangular
Glow Wire Rating	Standard Part - Not Glow Wire
Prewired	No
Grade	Commercial
Boxmount	No
Header Type	Unshrouded
Product Type	Connector
Connector & Housing Type	Plug
Connector System	Wire-to-Board
Insertion Force Type	Zero Insertion Force (ZIF)
Connector & Contact Terminates To	Wire & Cable
Configuration Features	
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Number of Boardlocks	4
Preloaded	Yes
Number of Signal Positions	156
Keying	Υ
Coaxial Socket	Without



Number of Power Positions	0
PCB Mount Orientation	Vertical
Number of Positions	260
Number of Rows	10
Panel Gasket	Without
Electrical Characteristics	
UL Voltage Rating	600 VDC
Operating Voltage	250 VDC
Body Features	
Rear Grommet	Without
Guide Pin	Without
Material	Glass-Reinforced Nylon
Contact Features	
Contact Transmits (Typical)	Signal
Contact Layout	Matrix
Contact Type	Tab
Shunts/Shorting Bars	Without
Contact Style	Vertical
Multiple Contact Types	Without
Signal Contact Material	Copper Alloy
Contact Underplating Material	Nickel
Contact Plating Material	Gold
Contact Current Rating (Max)	.8 A
Termination Features	
Termination Post Length	3.78 mm[.1488 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Termination Method to Wire & Cable	Solder
Mechanical Attachment	
Fastener Type	Slotted Hex
Flange	With
Mounting Angle	Vertical
Mounting Hole Diameter	1.1 mm[.0433 in]



Mating Hardware	Quick Disconnect
Mounting Hole Thread Size	M3
PCB Mount Alignment Type	Standard Polarized Tail
Lock Type	Positive Lock
Mounting Holes	With
Mounting Hardware	Without
PCB Mount Alignment	Without
Mating Alignment	With
Mating Alignment Type	Guide Hole
Mating Retention	With
Mating Retention Type	Locking Latch
PCB Mount Retention	With
PCB Mount Retention Type	Mounting Hole
Housing Features	
Housing Color	Black
Housing Material	Nylon Resin
	.1 in
Dimensions	.1 in
Dimensions  PCB Thickness (Recommended)	.1 in 1.6 mm[.063 in]
PCB Thickness (Recommended)	1.6 mm[.063 in]
PCB Thickness (Recommended) Row-to-Row Spacing	1.6 mm[.063 in]
PCB Thickness (Recommended)  Row-to-Row Spacing  Usage Conditions	1.6 mm[.063 in] 2.54 mm[.1 in]
PCB Thickness (Recommended)  Row-to-Row Spacing  Usage Conditions  High Temperature Header	1.6 mm[.063 in] 2.54 mm[.1 in] No
PCB Thickness (Recommended) Row-to-Row Spacing  Usage Conditions  High Temperature Header  Operating Temperature Range	1.6 mm[.063 in] 2.54 mm[.1 in] No
PCB Thickness (Recommended) Row-to-Row Spacing  Usage Conditions  High Temperature Header  Operating Temperature Range  Operation/Application	1.6 mm[.063 in] 2.54 mm[.1 in]  No -55 – 85 °C[-67 – 185 °F]
PCB Thickness (Recommended) Row-to-Row Spacing  Usage Conditions  High Temperature Header  Operating Temperature Range  Operation/Application  Assembly Integration Feature	1.6 mm[.063 in] 2.54 mm[.1 in]  No -55 – 85 °C[-67 – 185 °F]  Without
PCB Thickness (Recommended) Row-to-Row Spacing  Usage Conditions  High Temperature Header  Operating Temperature Range  Operation/Application  Assembly Integration Feature  For Use With	1.6 mm[.063 in] 2.54 mm[.1 in]  No -55 – 85 °C[-67 – 185 °F]  Without  Standard Connectors
PCB Thickness (Recommended) Row-to-Row Spacing Usage Conditions High Temperature Header Operating Temperature Range Operation/Application Assembly Integration Feature For Use With Halogen Free	1.6 mm[.063 in]  2.54 mm[.1 in]  No  -55 - 85 °C[-67 - 185 °F]  Without  Standard Connectors  Yes
PCB Thickness (Recommended) Row-to-Row Spacing  Usage Conditions  High Temperature Header Operating Temperature Range  Operation/Application  Assembly Integration Feature  For Use With  Halogen Free  Shielded	1.6 mm[.063 in]  2.54 mm[.1 in]  No  -55 - 85 °C[-67 - 185 °F]  Without  Standard Connectors  Yes
PCB Thickness (Recommended) Row-to-Row Spacing  Usage Conditions  High Temperature Header Operating Temperature Range  Operation/Application  Assembly Integration Feature  For Use With  Halogen Free Shielded  Identification Marking	1.6 mm[.063 in]  2.54 mm[.1 in]  No  -55 – 85 °C[-67 – 185 °F]  Without  Standard Connectors  Yes  No



Agency/Standard	UL
UL File Number	E28476
UL Rating	Recognized
VDE Tested	No
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	5
Packaging Method	Carton

### **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2020 (205) Candidate List Declared Against: JAN 2020 (205) Does not contain REACH SVHC
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2020 (205) Candidate List Declared Against: JAN 2020 (205)
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Wave solder capable to 260°C

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulations, TE's information on SVHC in articles for this part number is still based on the European Chemical Agency (ECHA) 'Guidance on requirements for substances in articles' (Version: 2, April 2011), applying the 0.1% weight on weight concentration threshold at the finished product level. TE is aware of the European Court of Justice ruling of September 10th, 2015 also known as O5A (Once An Article Always An Article) stating that, in case of 'complex object', the threshold for a SVHC must be applied to both the product as a whole and simultaneously to each of the articles forming part of its composition. TE has evaluated this ruling based on the new ECHA "Guidance on requirements for substances in articles" (June 2017, version 4.0) and will be updating its statements accordingly.

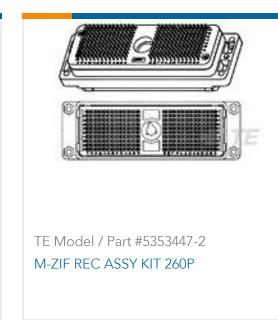


# Customers Also Bought



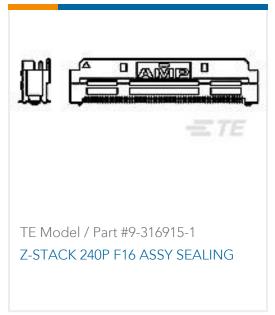












### **Documents**

## **Product Drawings**

M-ZIF PLUG ASSY 260P 3.8SOLDER

Japanese

# **Product Specifications**

M-ZIF Connector

Japanese

**Product Specification** 

Japanese

**Product Specification** 

English

M-ZIF Connector

English